



# Ultralow Noise Precision Op Amp

ANALOG DEVICES INC

65E D

**AD OP-27**

### 1.1 Scope.

This specification covers the detail requirements for an ultralow noise and low offset voltage bipolar amplifier.

### 1.2 Part Number.

The complete part number per Table 1 of this specification is as follows:

Device	Part Number
-1	AD OP-27C(X)/883B
-2	AD OP-27B(X)/883B
-3	AD OP-27A(X)/883B

### 1.2.3 Case Outline.

See Appendix 1 of General Specification ADI-M-1000: package outline:

(X)	Package	Description
Q	Q-8	8-Pin Cerdip
H	H-08A	8-Pin TO-99 Metal Can

### 1.3 Absolute Maximum Ratings. ( $T_A = +25^\circ\text{C}$ unless otherwise noted)

Supply Voltage	$\pm 18\text{V}$
Internal Power Dissipation <sup>1</sup>	500mW
Differential Input Voltage <sup>2</sup>	$\pm 0.7\text{V}$
Input Voltage	$\pm V_S$
Output Short Circuit Duration	Indefinite
Storage Temperature Range	$-65^\circ\text{C}$ to $+150^\circ\text{C}$
Operating Temperature Range	
AD OP-27A, AD OP-27B, AD OP-27C	$-55^\circ\text{C}$ to $+125^\circ\text{C}$
Lead Temperature Range (Soldering 60sec)	$+300^\circ\text{C}$
Differential Input Current <sup>2</sup>	$\pm 25\text{mA}$

#### NOTE

<sup>1</sup>Maximum package power dissipation vs. ambient temperature.

Package Type	MAXIMUM AMBIENT	DERATE ABOVE MAXIMUM
	Temperature for Rating	Ambient Temperature
TO-99(H)	$80^\circ\text{C}$	$7.1\text{mW}/^\circ\text{C}$
Cerdip(Q)	$75^\circ\text{C}$	$6.7\text{mW}/^\circ\text{C}$

<sup>2</sup>The input pins of this amplifier are protected by back-to-back diodes. If the differential voltage exceeds  $\pm 0.7\text{V}$ , external series protection resistors should be added to limit the input current to less than 25mA.

### 1.5 Thermal Characteristics.

Thermal Resistance $\theta_{JC}$	$= 65^\circ\text{C}/\text{W}$ for H-08A
$\theta_{JA}$	$= 150^\circ\text{C}/\text{W}$ for H-08A
$\theta_{JC}$	$= 22^\circ\text{C}/\text{W}$ for Q-8
$\theta_{JA}$	$= 110^\circ\text{C}/\text{W}$ for Q-8

12  
OPERATIONAL AMPLIFIERS

# AD OP-27—SPECIFICATIONS

Table 1.

Test	Symbol	Device	Sub Group 1	Sub Group 2, 3	Sub Group 4	Test Condition <sup>1</sup>	Units
Gain Open Loop	A <sub>OL</sub>	-1	700	300		R <sub>L</sub> ≥ 2kΩ, V <sub>OUT</sub> = ± 10V	V/mV min
			1000	500		R <sub>L</sub> ≥ 2kΩ, V <sub>OUT</sub> = ± 10V	
		-3	800			R <sub>L</sub> ≥ 1kΩ, V <sub>OUT</sub> = ± 10V	
			1000	600		R <sub>L</sub> ≥ 2kΩ, V <sub>OUT</sub> = ± 10V	
			800			R <sub>L</sub> ≥ 1kΩ, V <sub>OUT</sub> = ± 10V	
Output Voltage Swing	V <sub>OUT</sub>	-1	11.5	10.5		R <sub>L</sub> ≥ 2kΩ	± V min
			10.0			R <sub>L</sub> = 600Ω	
		-2	12.0	11.0		R <sub>L</sub> ≥ 2kΩ	
			10.0			R <sub>L</sub> = 600Ω	
		-3	12.0	11.5		R <sub>L</sub> ≥ 2kΩ	
			10.0			R <sub>L</sub> = 600Ω	
Input Offset Voltage	V <sub>OS</sub>	-1	100	300			± μV max
		-2	60	200			
		-3		60	25		
Input Offset Drift <sup>2</sup>	TCV <sub>OS</sub>	-1		1.8			± μV/°C max
		-2		1.3			
		-3		0.6			
Input Offset Current	I <sub>OS</sub>	-1	75	135			± nA max
		-2	50	85			
		-3	35	50			
Input Bias Current	I <sub>B</sub>	-1	80	150			± nA max
		-2	55	95			
		-3	40	60			
Common-Mode Rejection Ratio	CMRR	-1	100	94		V <sub>CM</sub> = ± 11V	dB min
		-2	106	100		V <sub>CM</sub> = ± 10V for Subgroup 2, 3	
		-3	114	108			
Common-Mode Voltage Range	CMVR	-1	11.0	10.2			± V min
		-2, 3	11.0	10.3			
Power Supply Current	I <sub>Q</sub>	-1	5.6			V <sub>S</sub> = ± 15V	mA max
		-2, 3	4.6				
Power Consumption	P <sub>D</sub>	-1	170			V <sub>OUT</sub> = 0V	mW max
		-2, 3	140				
Power Supply Rejection	PSR	-1	20	51		V <sub>S</sub> = ± 4V to ± 18V	μV/V max
		-2	10	20		V <sub>S</sub> = ± 4.5V to ± 18V	
		-3	10	16		Subgroup 2, 3	

NOTES

<sup>1</sup>V<sub>S</sub> = ± 15 unless otherwise noted.

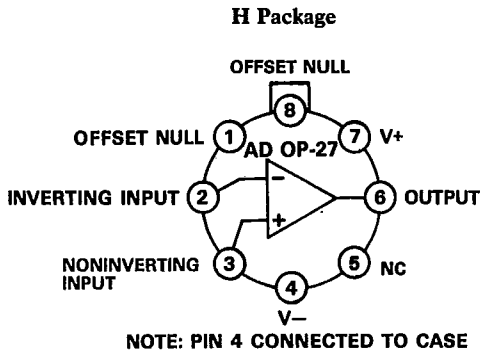
<sup>2</sup>TCV<sub>OS</sub> is within specification unnullled, or when nulled with R<sub>P</sub> = 8 to 20kΩ.

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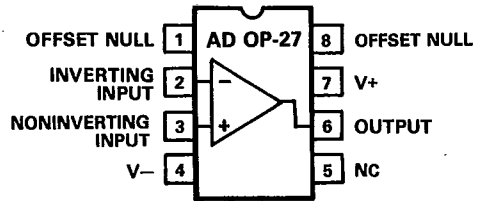
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3.2.1 Functional Block Diagram and Terminal Assignments.

Top View



Q Package (Cerdip)



3.2.4 Microcircuit Technology Group.

This microcircuit is covered by technology group (49).

4.2.1 Life Test/Burn-In Circuit.

Steady state life test is per MIL-STD-883 Method 1005. Burn-in is per MIL-STD-883 Method 1015 test condition (B).

